

# LED\_Audio\_DevPack

rev. 1.0

Item Number	Part Reference	Quantity	Value	Description	MPN	Manufacturer	Part Number
1	C3	1	1uF	CAPACITORS, CERAMIC, 1uF, 15%, X5R, 10V, 0603, SMD	GRM188R61A105KA61D	MURATA	02-01389
2	C42	1	4.7uF	CAPACITOR, CERAMIC X5R, 4.7uF, 6.3V, -10%/+10%, -55DEGC/+85DEGC, 0603, SMD	GRM188R60J475KE19D	MURATA	02-02418
3	C392	1	22pF	CAPACITOR, CERAMIC COG/NPO, 22pF, 50V, -5%/+5%, -55DEGC/+125DEGC, 0402, SMD	GRM1555C1H220JA01D	MURATA	02-04373
4	C393	1	10uF	CAPACITOR, CERAMIC X5R, 10uF, 6.3V, -20%/+20%, -55DEGC/+85DEGC, 0603, SMD	GRM188R60J106ME47D	MURATA	02-02419
5	C395 C396	2	22uF	CAPACITOR, CERAMIC X5R, 22uF, 4V, -20%/+20%, -55DEGC/+85DEGC, 0603, SMD	GRM188R60G226MEA0D	MURATA	02-04481
6	C397 C398	2	10uF	CAPACITOR, CERAMIC X5R, 10uF, 6.3V, -20%/+20%, -55DEGC/+85DEGC, 0402, SMD	C1005X5R0J106M050BC	TDK	02-05030
7	C399 C400	2	22nF	CAPACITOR, CERAMIC X7R, 22nF, 50V, -10%/+10%, -55DEGC/+125DEGC, 0402, SMD	C0402C223K5RACTU	KEMET	02-05031
8	C401	1	10nF	CAPACITOR, CERAMIC X7R, 10nF, 50V, -10%/+10%, -55DEGC/+125DEGC, 0603, SMD	06035C103KAT2A	AVX	02-01889
9	C402	1	2.2uF	CAPACITOR, CERAMIC X5R, 2.2uF, 10V, -10%/+10%, -55DEGC/+85DEGC, 0603, SMD	GRM188R61A225KE34D	MURATA	02-02405
10	C403	1	47uF	CAPACITOR, CERAMIC, X5R, 47uF, 6.3V, -20%/+20%, -55DEGC/+85DEGC, 0805, SMD	CL21A476MQ9LRNC	SAMSUNG ELECTRO-MECHANICS	02-06067
11	CR1	1	LA CP7P	OPTO, LED, 2.6V, 0.35A, SMD	LA CP7P	OSRAM OPTO SEMICONDUCTORS	15-01107
12	CR2	1	LD CP7P	OPTO, LED, 3.7V, 0.35A, SMD	LD CP7P	OSRAM OPTO SEMICONDUCTORS	15-01110
13	CR3	1	LT CP7P	OPTO, LED, 3.5V, 0.35A, SMD	LT CP7P	OSRAM OPTO SEMICONDUCTORS	15-01109
14	CR4	1	LUW CP7P	OPTO, LED, 3.75V, 0.35A, SMD	LUW CP7P	OSRAM OPTO SEMICONDUCTORS	15-01108
15	FIDU1 FIDU2 FIDU3 FIDU4 FIDU5 FIDU6	6	FIDU_1.27mm	FIDUCIAL MARK, ROUND 1.27MM			19-00300
16	J2	1	LSS-110-01-F-DV-A-TR	CONNECTOR, HEADER, HI-SPEED SOCKET, FEMALE, STRAIGHT, 2 ROWS,20 PINS, PITCH 0.635mm, SMD	LSS-110-01-F-DV-A-TR	SAMTEC	06-03032
17	J4	1	47491-0001	CONNECTOR, MICRO-USB, 1 ROW, 5 PINS, PITCH 0.65mm, SMD	47491-0001	MOLEX	06-03288
18	L262	1	2.2uH	INDUCTOR, CHIP, 2.2uH, -20%/+20%, 1A, -55DEGC/+125DEGC, 1008, SMD	LQM2HPN2R2MJ0L	MURATA	03-06572
19	LBL1	1	HOT_SURFACE_LABEL	LABEL, HOT SURFACE LABEL			19-00364
20	LBL2	1	WARNING LASER BEAM	NON COMPONENT, LABEL, WARNING LASER BEAM			19-00413
21	M1	1	F12237_OSLO-CLUSTER-W	MECHANIC, LENS ARRAY, NOT APPLY	F12237_OSLO-CLUSTER-W	LEDiL	13-01025
22	Q1 Q2 Q3 Q4	4	BC817-16	TRANSISTOR, BIPOLAR NPN, 45V, 0.5A, 0.25W, SOT23-3, SMD	BC817-16,215	NXP	16-01211
23	R1	1	560	RESISTOR, THICK FILM, 560, -1%/+1%, 0.063W, 50V, -55DEGC/+155DEGC, 0402, SMD	CRCW0402560RFKED	VISHAY	01-00254
24	R2 R3 R4	3	1k	RESISTOR, THICK FILM, 1k, -1%/+1%, 0.063W, 50V, -55DEGC/+155DEGC, 0402, SMD	CRCW04021K00FKED	VISHAY	01-02075
25	R5	1	DNM	RESISTOR, DO NOT MOUNT, 0402, SMD			01-02475
26	R45	1	820k	RESISTOR, THICK FILM, 820k, -1%/+1%, 0.063W, 50V, -55DEGC/+155DEGC, 0402, SMD	RESISTOR_0402_820k_+/-1%_50V_0.063W_M_+/-100PPM	Manufacturer selection	01-12941
27	R46	1	160k	RESISTOR, THICK FILM, 160k, -1%/+1%, 0.063W, 50V, -55DEGC/+125DEGC, 0402, SMD	CRCW0402160kFKED	VISHAY	01-04875
28	R64	1	2.7	RESISTOR, THICK FILM, 2R7, 0.25W, 200V, -/+1%, -/+100ppm/deg, -55/+125degC, 1206, SMD	CRCW12062R70FNEA	VISHAY	01-06888
29	R65 R66 R67	3	1.00	RESISTOR, THICK FILM, 1R00, 0.25W, 200V, -/+1%, -/+200ppm/deg, -55/+125degC, 1206, SMD	CRCW12061R00FNEB	VISHAY	01-03445
30	R68	1	DNM	RESISTOR, DO NOT MOUNT, 0402, SMD	DNM	DO NOT MOUNT	01-02472
31	R70	1	2.2k	RESISTOR, THICK FILM, 2.2k, -1%/+1%, 0.063W, 50V, -55DEGC/+155DEGC, 0402, SMD	CRCW04022K20FKED	VISHAY	01-00239
32	R71 R72 R73	3	1.2k	RESISTOR, THICK FILM, 1.2k, -1%/+1%, 0.063W, 50V, -55DEGC/+155DEGC, 0402, SMD	CRCW04021K20FKED	VISHAY	01-00128
33	R74 R75	2	1.5k	RESISTOR, THICK FILM, 1.5k, -1%/+1%, 0.063W, 50V, -55DEGC/+155DEGC, 0402, SMD	RK73H1ETTP1501F	KOA SPEER	01-16854
34	R79 R80	2	2.7k	RESISTOR, THICK FILM, 2.7k, -1%/+1%, 0.063W, 50V, -55DEGC/+155DEGC, 0402, SMD	CRCW04022K70FKED	VISHAY	01-00241
35	R81	1	10k	RESISTOR, THICK FILM, 10k, -1%/+1%, 0.063W, 50V, -55DEGC/+155DEGC, 0402, SMD	CRCW040210K0FKED	VISHAY	01-00314
36	R82 R83 R85	3	0	RESISTOR, THICK FILM, 0, 0/+0.008R, 0.25W, 75V, -55DEGC/+155DEGC, 0603, SMD	CRCW06030000Z0EAHP	VISHAY	01-16898
37	R84	1	300k	RESISTOR, THICK FILM, 300k, -1%/+1%, 0.063W, 50V, -55DEGC/+155DEGC, 0402, SMD	CRCW0402300KFKED	VISHAY	01-00246
38	TP1 TP2 TP3 TP4 TP5	5	TP_2MMX2MM_SMD	NON COMPONENT, TESTPOINT, 2MM X 2MM, SMD			19-00238
39	TP12 TP13	2	TP_1.0mm_SMD	TESTPOINT 40mil/1mm SMD			19-00113
40	TP19 TP20 TP21 TP22	4	TP_40_PTH	NON COMPONENT, TESTPOINT 1.0MM HOLE, PTH			19-00158
41	U4	1	TPS62260	IC, ANALOG, STEPDOWN CONVERTER, VIN:2V TO 6V, VOUT: ADJ, SON6, SMD	TPS62260DRVT	TEXAS INSTRUMENTS	18-27835
42	U8	1	TAS2505	IC, DIGITAL AUDIO VIDEO, 1.5 V TO 1.95 V, QFN24, SMD	TAS2505IRGET	TEXAS INSTRUMENTS	18-28982
43	U9	1	TPS79933	IC, ANALOG, LOW DROPOUT LINEAR REGULATOR, VIN:2.7V TO 6.5V, VOUT:3.3V, DSBGA5, SMD	TPS79933YZUR	TEXAS INSTRUMENTS	18-29026

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